

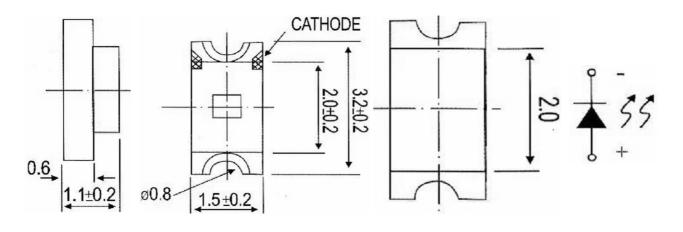


Applications

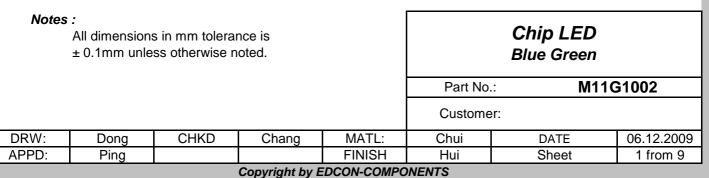
Interior automotive lighting

 Optical indicators
 Communication Products
 Backlighting
 Toys

Technical Drawing



Recommended Soldering Pattern



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Absolute Maximum Ratings

Ta=25°C

| Item | Symbol | InGaN / SiC | Unit |
|------------------------|-------------------|-------------|------|
| Power Dissipation | P _D | | mW |
| DC Forward Current | I _F | 20 | mA |
| Plused Forward Current | I _{FP} * | | mA |
| Reverse Voltage | V _R | | V |
| Operating Temperature | T _{OP} | | °C |
| Storage Temperature | T _{ST} | -55 to 100 | °C |

* 0.1 msec pulse, 10% duty cycle

Electrcal / Optical Characteristics

I_F=20mA Ta=25°C

| Ermitting Color | | Blue Green | | | | | |
|----------------------|-------------|------------|----------------|--|--|--|--|
| Material | InGaN / SiC | | | | | | |
| Forward Voltage | typ. | 3.5 | V _F | | | | |
| r orward voltage | max. | 4.3 | V _F | | | | |
| Wavelength | λD | 505 | nm | | | | |
| - | λP | | nm | | | | |
| typ. | Δλ | | nm | | | | |
| Color Temperature | min. | | K | | | | |
| | max. | | K | | | | |
| Luminous Intensity * | min. | 32 | mcd | | | | |
| Lumnous intensity | typ. | 55 | mcd | | | | |
| Reverse Current | max. | | μA | | | | |
| Viewing Angle | 2Θ1/2 | 130 | | | | | |

* Per NIST standards

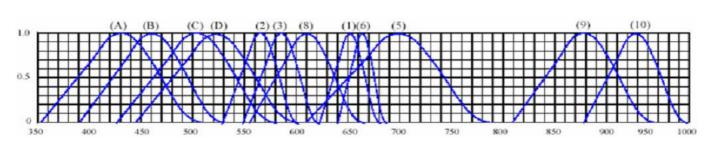
| | | | | | | Chip LED Blue Green | | | | | |
|-------|-------------------------------|---------------------------|-------|--------|---------|------------------------|------------|--|--|--|--|
| | | Part No.: M11G1002 | | | | | | | | | |
| | | | | | Custome | er: | | | | | |
| DRW: | Dong | CHKD | Chang | MATL: | Chui | DATE | 06.12.2009 | | | | |
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Curve



Wavelength (nm)

Relative Intensity vs Wavelength

| (1) | GaAsP / GaAs 655nm Red | (9) | GaAlAs 880nm |
|-----|---------------------------|------|-----------------|
| (2) | GaP | (10) | GaAs & GaAlAs |
| | 568nm Yellow Green | | 940nm |
| (3) | GaAsP / GaP | (A) | GaN |
| | 585nm Yellow | | 430nm Blue |
| (4) | GaAsP / GaP | (B) | InGaN |
| . , | 635nm Orange & Red | | 470nm Blue |
| (5) | GaP | (C) | InGaN |
| | 700nm Red | | 502nm Green |
| (6) | GaAlAs / GaAs | (D) | InGaN |
| | 660nm Red | | 523nm Green |
| (8) | GaAsP / GaP | | |
| . , | 610nm Red | | |

| | | | | | | Chip LED Blue Green | |
|-------|------|------|-------|--------|---------------------------|------------------------|------------|
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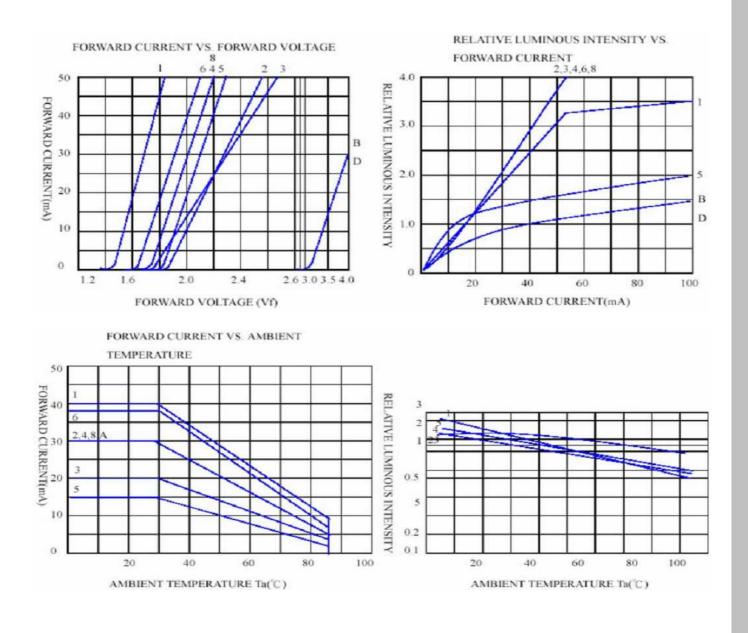
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Curve



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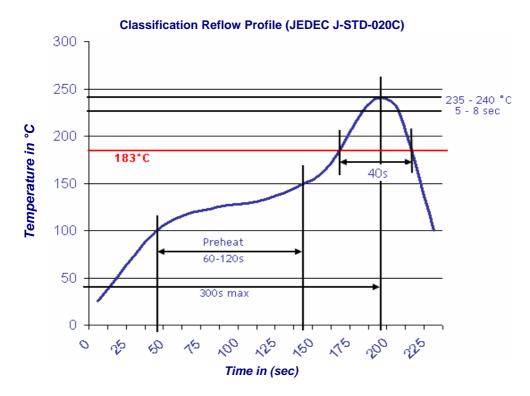
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Solder Condition

Lead Free Solder



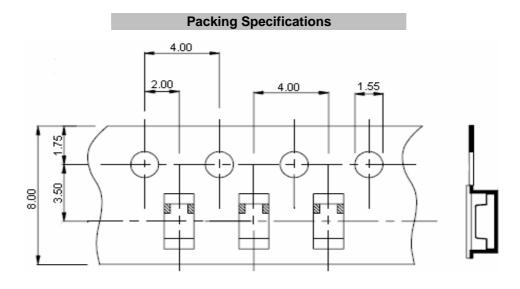
| | | | | Chip LED Blue Green | | | |
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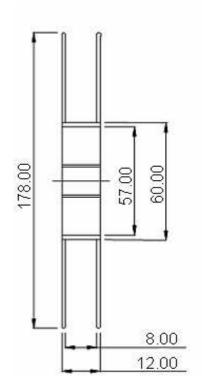
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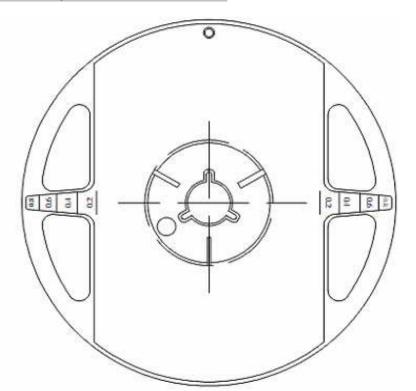






Reel Specifications





| | | | | Chip LED Blue Green | | | |
|-----------|---------|---------|--------|---------------------------|-------|------------|--|
| | | | | Part No.: M11G1002 | | | |
| | | | | Customer: | | | |
| DRW: Doi | ng CHKI | D Chang | MATL: | Chui | DATE | 06.12.2009 | |
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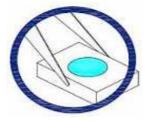




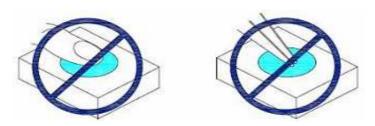
Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



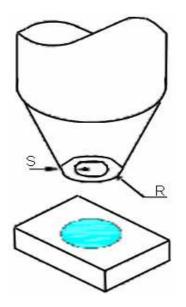
| | | | | Chip LED Blue Green | | | | |
|-------|-----------|------|--------------------|------------------------|----------|--------|------------|--|
| | | | | | Part No. | : M110 | G1002 | |
| | Customer: | | | | | | | |
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- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



| | | | | | Chip LED Blue Green | | | | | |
|------|-------------------------------|-------|--------|---------------------------|------------------------|------------|--|--|--|--|
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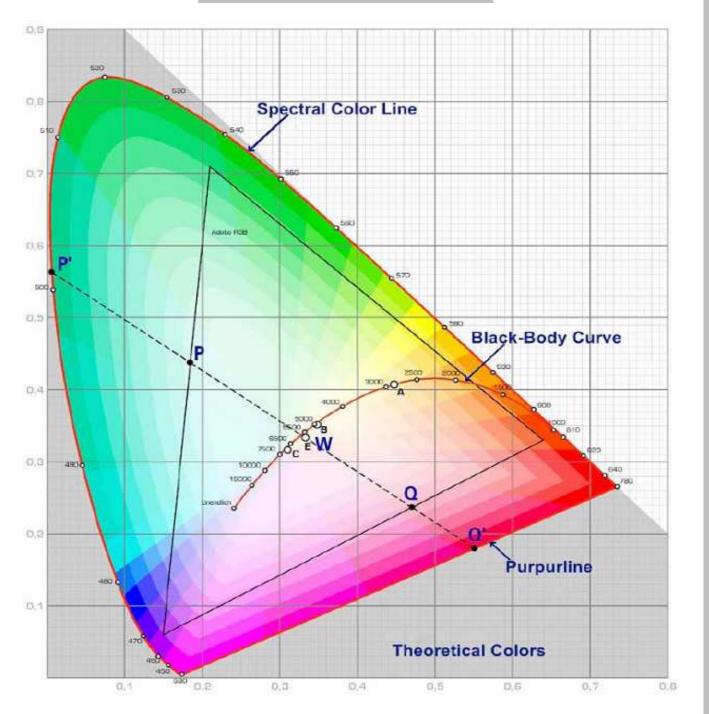
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Color table curve



| | | | | | Chip LED Blue Green | | |
|-------|------|------|-------|--------|---------------------------|-------|------------|
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